

Selection Guide

		7C261-20 7C263-20 7C264-20	7C261-25 7C263-25 7C264-25	7C261-35 7C263-35 7C264-35	7C261-45 7C263-45 7C264-45	7C261-55 7C263-55 7C264-55	Unit
Maximum Access Time		20	25	35	45	55	ns
Maximum Operating Current	Commercial	120	120	100	100	100	mA
	Military		140	120	120	120	mA
Maximum Standby Current (7C261 only)	Commercial	40	40	30	30	30	mA
	Military		40	30	30	30	mA

Maximum Ratings^[1]

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperatures -65°C to +150°C

Ambient Temperature with
Power Applied -55°C to +125°C

Supply Voltage to Ground Potential
(Pin 24 to Pin 12) -0.5V to +7.0V

DC Voltage Applied to Outputs
in High Z State -0.5V to +7.0V

DC Input Voltage -3.0V to + 7.0V

DC Program Voltage
(Pin 19 DIP, Pin 23 LCC) 13.0V

Static Discharge Voltage >2001V
(per MIL-STD-883, Method 3015)

Latch-Up Current >200 mA

UV Exposure 7258 Wsec/cm²

Operating Range

Range	Ambient Temperature	V _{CC}
Commercial	0°C to + 70°C	5V ± 10%
Military ^[2]	-55°C to + 125°C	5V ± 10%

Notes:

1. The voltage on any input or I/O pin cannot exceed the power pin during power-up.
2. T_A is the "instant on" case temperature.

Electrical Characteristics Over the Operating Range^[3,4]

			7C261-20, 25 7C263-20, 25 7C264-20, 25		7C261-35, 45, 55 7C263-35, 45, 55 7C264-35, 45, 55			
Parameter	Description	Test Conditions	Min.	Max.	Min.	Max.	Unit	
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = −2.0 mA	2.4				V	
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = −4.0 mA			2.4		V	
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8 mA (6 mA Mil)		0.4			V	
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 16 mA				0.4	V	
V _{IH}	Input HIGH Level		2.0		2.0		V	
V _{IL}	Input LOW Level			0.8		0.8	V	
I _{IX}	Input Current	GND ≤ V _{IN} ≤ V _{CC}	−10	+10	−10	+10	μA	
V _{CD}	Input Diode Clamp Voltage		Note 4		Note 4			
I _{OZ}	Output Leakage Current	GND ≤ V _{OUT} ≤ V _{CC} Output Disabled	Com'l	−10	+10	−10	+10	μA
			Mil	−40	+40	−40	+40	μA
I _{OS}	Output Short Circuit Current ^[5]	V _{CC} = Max., V _{OUT} = GND	−20	−90	−20	−90	mA	
I _{CC}	Power Supply Current	V _{CC} = Max., f = Max. I _{OUT} = 0 mA	Com'l		120		100	mA
			Mil		140		120	
I _{SB}	Standby Supply Current (7C261)	V _{CC} = Max., CS ≥ V _{IH}	Com'l		40		30	mA
			Mil		40		30	
V _{PP}	Programming Supply Voltage		12	13	12	13	V	
I _{PP}	Programming Supply Current			50		50	mA	
V _{IHP}	Input HIGH Programming Voltage		4.75		4.75		V	
V _{ILP}	Input LOW Programming Voltage			0.4		0.4	V	

Capacitance^[4]

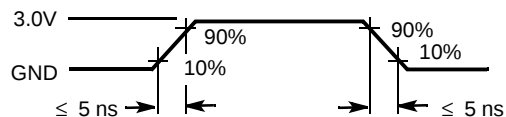
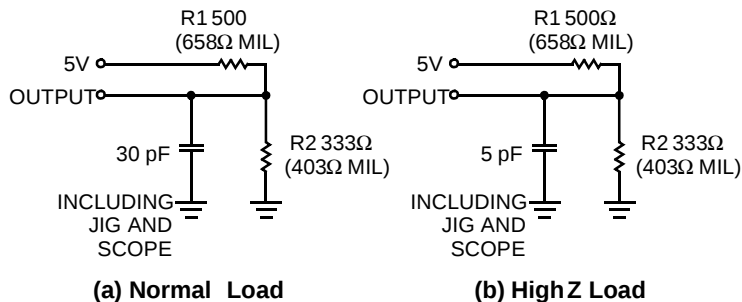
Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V	10	pF
C _{OUT}	Output Capacitance		10	pF

Notes:

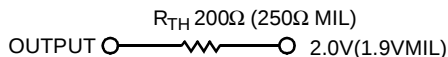
- See the last page of this specification for Group A subgroup testing information.
- See the "Introduction to CMOS PROMs" section of the Cypress Data Book for general information on testing.
- For test purposes, not more than one output at a time should be shorted. Short circuit test duration should not exceed 30 seconds.]

AC Test Loads and Waveforms^[4]

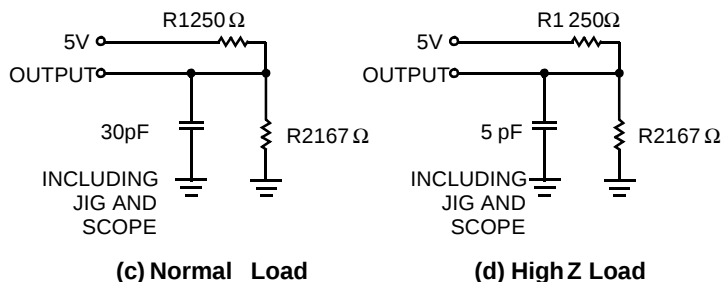
Test Load for -20 through -30 speeds



Equivalent to: THÉVENIN EQUIVALENT



Test Load for -35 through -55 speeds



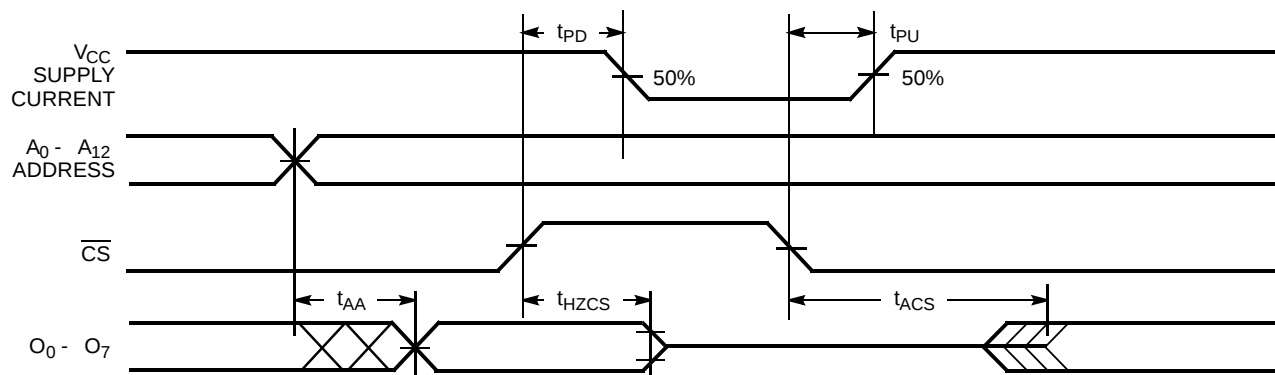
Equivalent to: THÉVENIN EQUIVALENT



Switching Characteristics Over the Operating Range^[1,3,4]

Parameter	Description	7C261-20 7C263-20 7C264-20		7C261-25 7C263-25 7C264-25		7C261-35 7C263-35 7C264-35		7C261-45 7C263-45 7C264-45		7C261-55 7C263-55 7C264-55		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t_{AA}	Address to Output Valid		20		25		35		45		55	ns
t_{HZCS1}	Chip Select Inactive to High Z (7C263 and 7C264)		12		12		20		30		35	ns
t_{HZCS2}	Chip Select Inactive to High Z (7C261)		20		25		35		45		55	ns
t_{ACS1}	Chip Select Active to Output Valid (7C263 and 7C264)		12		12		20		30		35	ns
t_{ACS2}	Chip Select Active to Output Valid (7C261)		20		25		35		45		55	ns
t_{PU}	Chip Select Active to Power-Up (7C261)	0		0		0		0		0		ns
t_{PD}	Chip Select Inactive to Power-Down (7C261)		20		25		35		45		55	ns

Switching Waveforms^[4]



Erase Characteristics

Wavelengths of light less than 4000 angstroms begin to erase the devices in the windowed package. For this reason, an opaque label should be placed over the window if the PROM is exposed to sunlight or fluorescent lighting for extended periods of time.

The recommended dose of ultraviolet light for erasure is a wavelength of 2537 angstroms for a minimum dose (UV intensity multiplied by exposure time) of 25 Wsec/cm². For an ultraviolet lamp with a 12 mW/cm² power rating, the exposure time would be approximately 35 minutes. The 7C261 or 7C263 needs to be within 1 inch of the lamp during erasure. Permanent damage may result if the PROM is exposed to high-intensity UV light for an extended period of time. 7258 Wsec/cm² is the recommended maximum dosage.

Operating Modes

Read

Read is the normal operating mode for programmed device. In this mode, all signals are normal TTL levels. The PROM is addressed with a 13-bit field, a chip select, (active LOW), is applied to the CS pin, and the contents of the addressed location appear on the data out pins.

Program, Program Inhibit, Program Verify

These modes are entered by placing a high voltage V_{PP} on pin 19, with pins 18 and 20 set to V_{ILP} . In this state, pin 21 becomes a latch signal, allowing the upper 5 address bits to be latched into an onboard register, pin 22 becomes an active LOW program (PGM) signal and pin 23 becomes an active LOW verify (VFY) signal. Pins 22 and 23 should never be active LOW at the same time. The PROGRAM mode exists when PGM is LOW, and VFY is HIGH. The verify mode exists when the reverse is true, PGM HIGH and VFY LOW and the program inhibit mode is entered with both PGM and VFY HIGH. Program inhibit is specifically provided to allow data to be placed on and removed from the data pins without conflict.

Table 1. Mode Selection

Mode		Pin Function ^[6, 7]						
		Read or Output Disable	A ₁₂	A ₁₁	A ₁₀	A ₉	A ₈	CS
		Program	NA	V _{PP}	LATCH	PGM	VFY	CS
Read			A ₁₂	A ₁₁	A ₁₀	A ₉	A ₈	V _{IL}
Output Disable			A ₁₂	A ₁₁	A ₁₀	A ₉	A ₈	V _{IH}
Program			V _{ILP}	V _{PP}	V _{ILP}	V _{ILP}	V _{IHP}	V _{ILP}
Program Inhibit			V _{ILP}	V _{PP}	V _{ILP}	V _{IHP}	V _{IHP}	V _{ILP}
Program Verify			V _{ILP}	V _{PP}	V _{ILP}	V _{IHP}	V _{ILP}	V _{ILP}
Blank Check			V _{ILP}	V _{PP}	V _{ILP}	V _{IHP}	V _{ILP}	V _{ILP}

Notes:

6. X = "don't care" but not to exceed $V_{CC} \pm 5\%$.
7. Addresses A₈-A₁₂ must be latched through lines A₀-A₄ in programming modes.

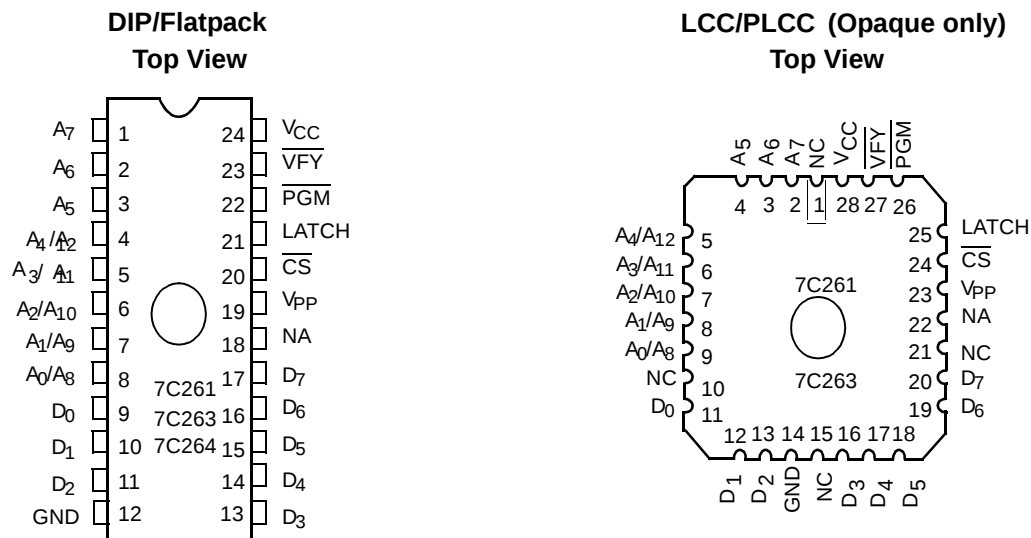


Figure 1. Programming Pinouts

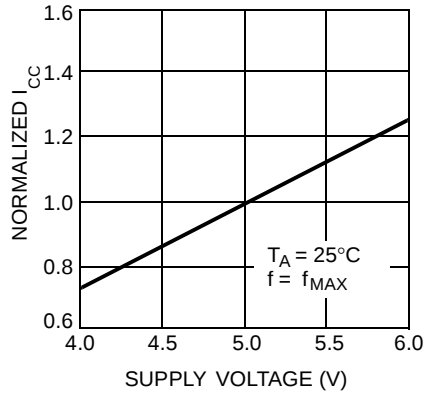
Programming Information

Programming support is available from Cypress as well as from a number of third-party software vendors. For detailed programming information, including a listing of software

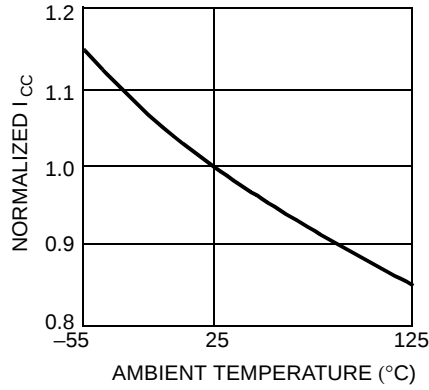
packages, please see the PROM Programming Information located at the end of this section. Programming algorithms can be obtained from any Cypress representative.

Typical DC and AC Characteristics

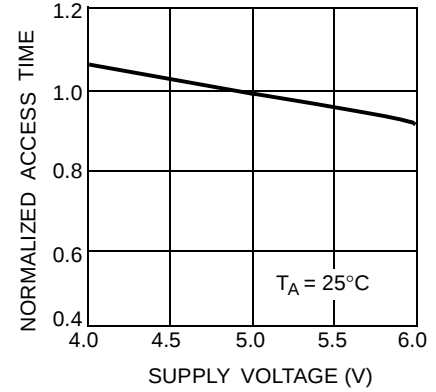
**NORMALIZED SUPPLY CURRENT
vs. SUPPLY VOLTAGE**



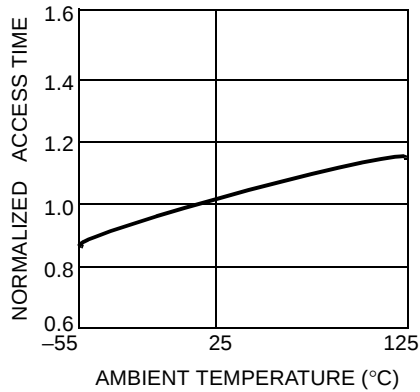
**NORMALIZED SUPPLY CURRENT
vs. AMBIENT TEMPERATURE**



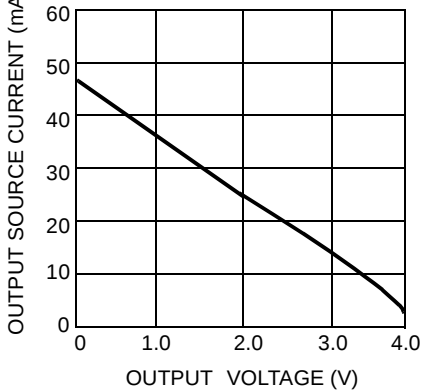
**NORMALIZED ACCESS TIME
vs. SUPPLY VOLTAGE**



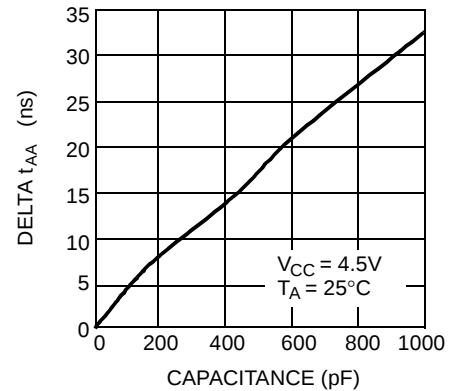
**NORMALIZED ACCESS TIME
vs. TEMPERATURE**



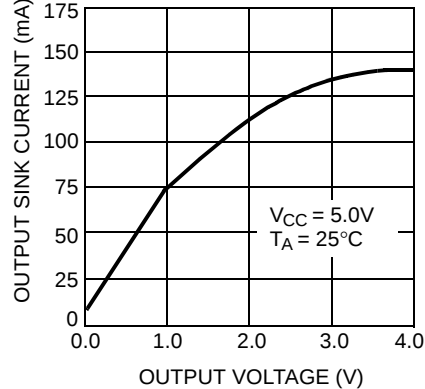
**OUTPUT SOURCE CURRENT
vs. VOLTAGE**



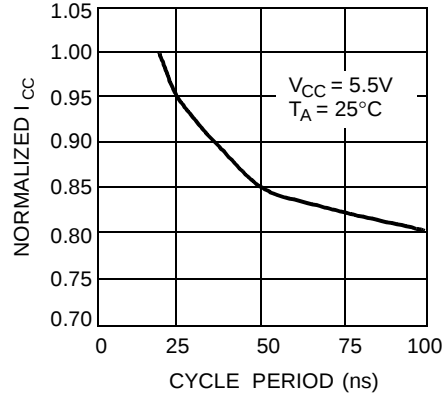
**TYPICAL ACCESS TIME CHANGE
vs. OUTPUT LOADING**



**OUTPUT SINK CURRENT
vs. OUTPUT VOLTAGE**



**NORMALIZED SUPPLY CURRENT
vs. CYCLE PERIOD**



Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
20	CY7C261-20PC	P13	24-Lead (300-Mil) Molded DIP	Commercial
	CY7C261-20WC	W14	24-Lead (300-Mil) Windowed CerDIP	
25	CY7C261-25JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C261-25PC	P13	24-Lead (300-Mil) Molded DIP	Military
	CY7C261-25WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
35	CY7C261-35PC	P13	24-Lead (300-Mil) Molded DIP	Commercial
	CY7C261-35WC	W14	24-Lead (300-Mil) Windowed CerDIP	Military
	CY7C261-35WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
45	CY7C261-45PC	P13	224-Lead (300-Mil) Molded DIP	Commercial
	CY7C261-45WC	W14	24-Lead (300-Mil) Windowed CerDIP	Military
	CY7C261-45WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
55	CY7C261-55WC	W14	24-Lead (300-Mil) Windowed CerDIP	Commercial
20	CY7C263-20JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C263-20PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C263-20WC	W14	24-Lead (300-Mil) Windowed CerDIP	
25	CY7C263-25JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C263-25PC	P13	24-Lead (300-Mil) Molded DIP	
	CY7C263-25WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	CY7C263-25DMB	D14	24-Lead (300-Mil) CerDIP	Military
	CY7C263-25QMB	Q64	28-Pin Windowed Leadless Chip Carrier	
	CY7C263-25WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
35	CY7C263-35PC	P13	24-Lead (300-Mil) Molded DIP	Commercial
	CY7C263-35WC	W14	24-Lead (300-Mil) Windowed CerDIP	Military
	CY7C263-35WMB	W14	24-Lead (300-Mil) Windowed CerDIP	
45	CY7C263-45WMB	W14	24-Lead (300-Mil) Windowed CerDIP	Military
55	CY7C263-55JI	J64	28-Lead Plastic Leaded Chip Carrier	Industrial
	CY7C263-55PC	P13	24-Lead (300-Mil) Molded DIP	Commercial
	CY7C263-55WMB	W14	24-Lead (300-Mil) Windowed CerDIP	Military
35	CY7C264-35PC	P11	24-Lead (600-Mil) Molded DIP	Commercial
45	CY7C264-45WC	W12	24-Lead (600-Mil) Windowed CerDIP	Commercial
	CY7C264-45WMB	W12	24-Lead (600-Mil) Windowed CerDIP	Military
55	CY7C264-55WC	W12	24-Lead (600-Mil) Windowed CerDIP	Commercial

MILITARY SPECIFICATION
Group A Subgroup Testing
DC Characteristics

Parameter	Subgroups
V_{OH}	1, 2, 3
V_{OL}	1, 2, 3
V_{IH}	1, 2, 3
V_{IL}	1, 2, 3
I_{IX}	1, 2, 3
I_{OZ}	1, 2, 3
I_{CC}	1, 2, 3
$I_{SB}^{[8]}$	1, 2, 3

Switching Characteristics

Parameter	Subgroups
t_{AA}	7, 8, 9, 10, 11
$t_{ACS1}^{[9]}$	7, 8, 9, 10, 11
$t_{ACS2}^{[8]}$	7, 8, 9, 10, 11

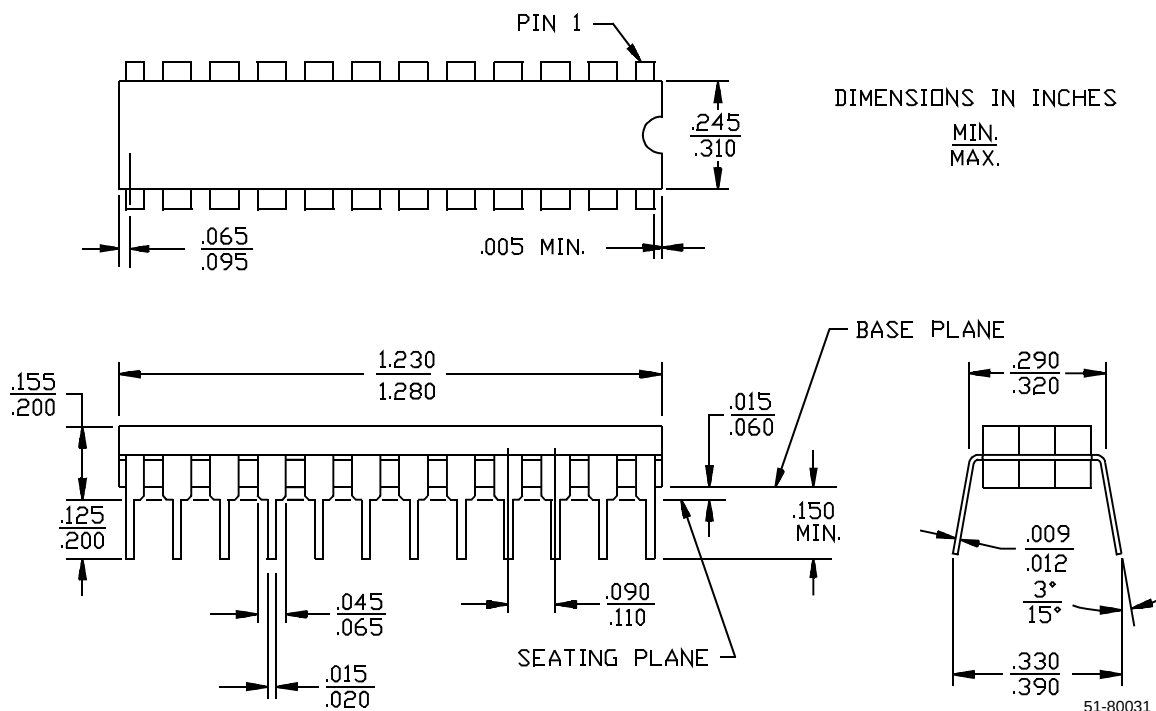
Notes:

- 8. 7C261 only.
- 9. 7C263 and 7C264 only.

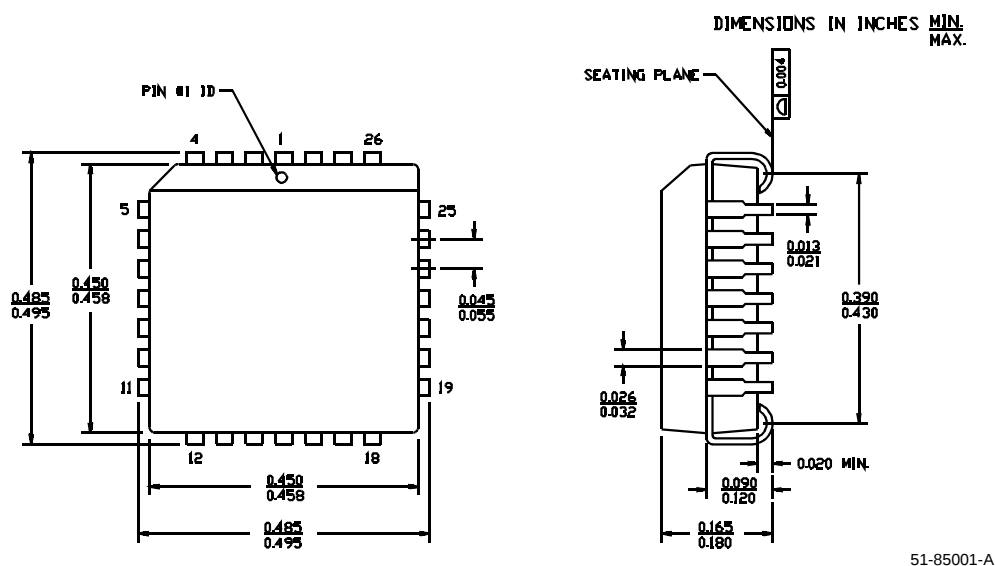
Package Diagrams

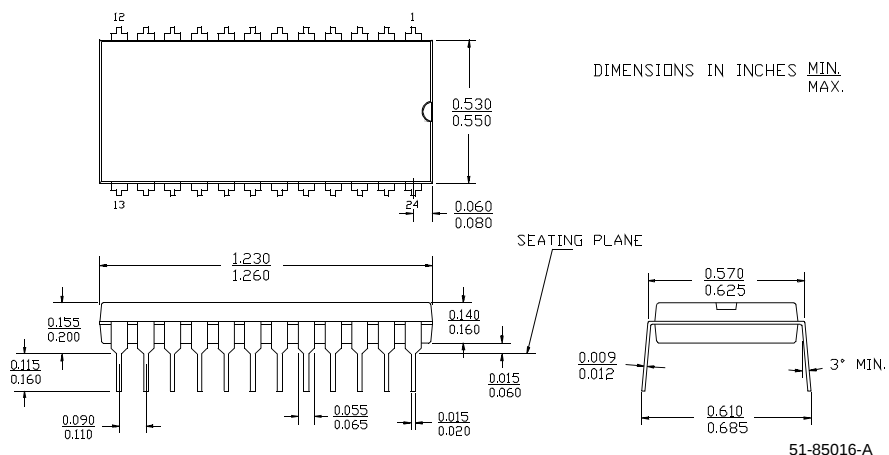
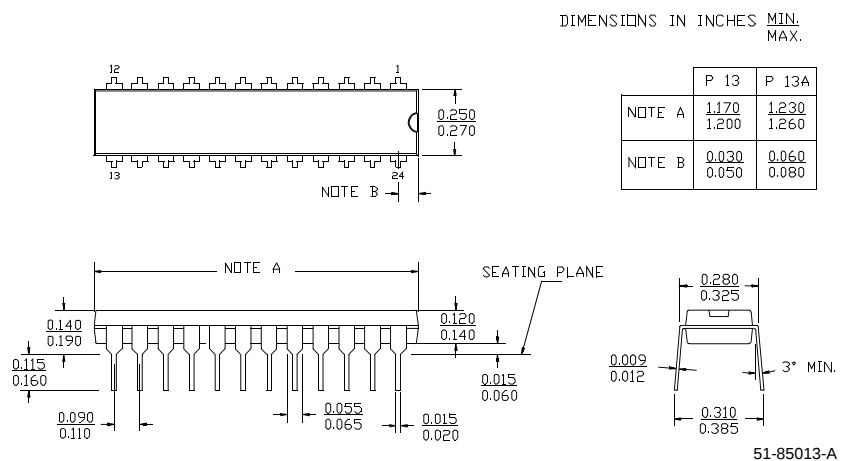
24-Lead (300-Mil) CerDIP D14

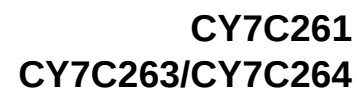
MIL-STD-1835 D-9 Config.A



28-Lead Plastic Leaded Chip Carrier J64

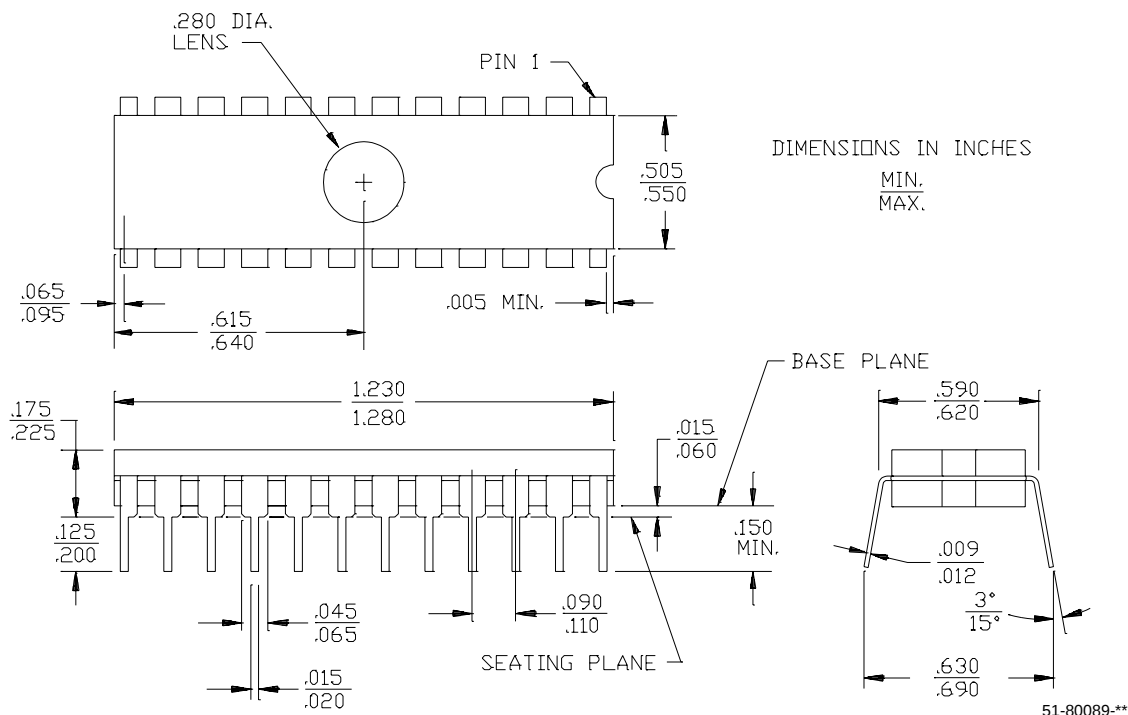


Package Diagrams (continued)
24-Lead (600-Mil) Molded DIP P11

24-Lead (300-Mil) Molded DIP P13/P13A


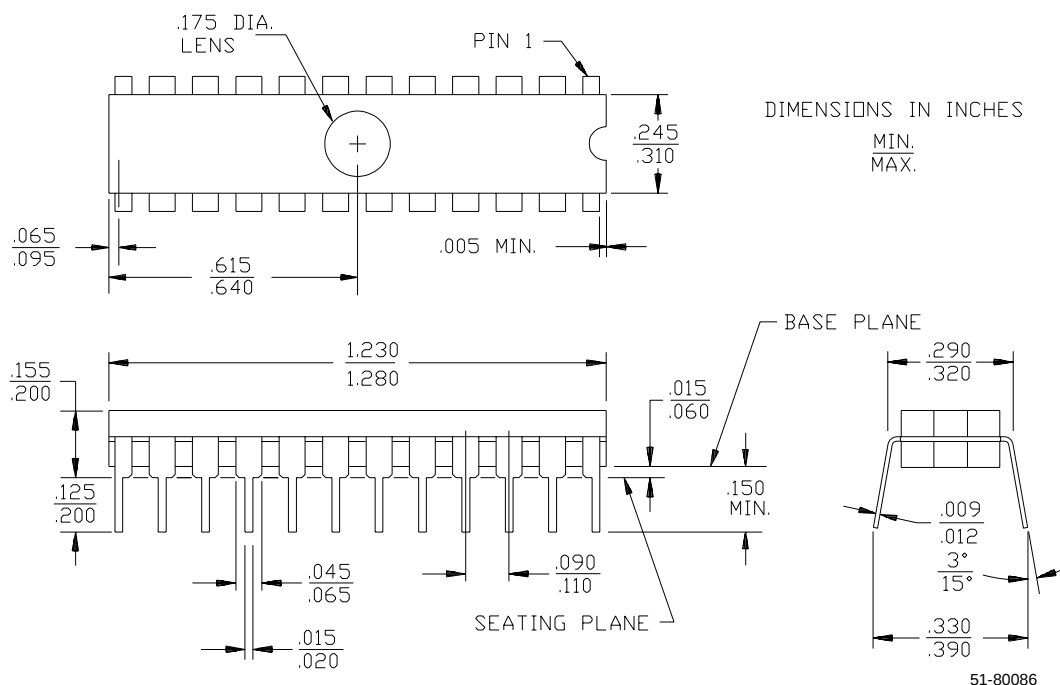


Package Diagrams (continued)

24-Lead (600-Mil) Windowed CerDIP W12
MIL-STD-1835 D-3 Config. A



24-Lead (300-Mil) Windowed CerDIP W14
MIL-STD-1835 D-9 Config. A



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Document History Page

Document Title: CY7C261 CY7C263/CY7C264 8K x 8 Power Switched and Reprogrammable PROM Document Number: 38-04010				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	113866	3/6/02	DSG	Change from Spec number: 38-00005 to 38-04010
*A	118895	10/09/02	GBI	Update Ordering Information
*B	122251	12/28/02	RBI	Add power up requirements to Maximum Ratings information